

Epoxy Dissolver

Cured Epoxy Removal

WARNING!



GHS07

Refer to the SDS document for additional safety information.

Instructions:

- 1) To shorten the time it takes to remove the encapsulant, cut or grind away as much of the epoxy from the specimen as possible.
- 2) Pour Epoxy Dissolver into a glass, aluminum, or stainless steel beaker. **Do not use a plastic container.** Submerge the sample completely in Epoxy Dissolver.
- 3) Place the beaker onto a hot plate and heat to 150 °C (302 °F). Lower temperatures may be used; however, the Epoxy Dissolver may not be as effective. Use the maximum heat that the sample can withstand, up to 150 °C, for fastest decapsulation. Upon heating, the solution may darken. **Use in a well-ventilated area, and do not heat with an open flame or oven.**
- 4) After the epoxy has been removed from the sample, allow the Epoxy Dissolver to cool to room temperature. Use metal tongs to remove the sample from the beaker.
- 5) Wash the sample in water, isopropyl alcohol, or acetone to remove any residual Epoxy Dissolver.
- 6) Epoxy Dissolver will cause epoxy to flake off; it will not go fully into solution. Filtering away solid materials from the Epoxy Dissolver will allow it to be reused.

Storage: Store above 21 °C (70 °F). Epoxy Dissolver may crystallize/freeze below 16 °C (60 °F); warming above 21 °C will dissolve the crystallized solids. The crystallization will not affect the stability or effectiveness.

Description

Epoxy Dissolver is a powerful blend of solvents designed for the removal of cured epoxy systems. It is particularly effective against transfer molded epoxy systems. It is not a true solvent for epoxies; it causes disintegration of these cured systems by stretching and breaking the polymeric bonds of the cured materials. It has a neutral pH, and it will not affect electronic materials in active components, including silicon.

Appearance

Clear Pink Liquid

Odor

Fruity

Solubility

Miscible with Water

Specific Gravity

1.1

Boiling Point

189 °C (372 °F)

Flash Point

89 °C (192 °F)

Auto-Ignition Point

300 °C (572 °F)

Vapor Pressure

0.46 mm/Hg @ 20 °C (68 °F)

Vapor Density

2.7 (Relative to Air = 1)

VOC Content

9.1 lbs/gal

Reactivity

Reacts with acids. May react with oxidizing agents.

Applications

Most epoxy systems can be removed when Epoxy Dissolver is heated to 150 °C. It is not selective and will attack most thermoplastic materials, wire coatings, and many thermosetting coatings and materials. It works with the following materials: epoxy casting compounds and epoxy molding compounds, including Allied's EpoxyMount, EpoxySet, and EpoxyBond 110. It may also work with other epoxy systems; experiment at your own risk, and observe proper safety precautions.